



US00D885443S

(12) **United States Design Patent** (10) **Patent No.:** **US D885,443 S**
Tsuji (45) **Date of Patent:** **** May 26, 2020**

(54) **SEAL MEMBER FOR USE IN SEMICONDUCTOR PRODUCTION APPARATUS**

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(73) Assignee: **Valqua, Ltd.**, Tokyo (JP)

(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (12) Cl.** **15-03**

(52) **U.S. Cl.**
USPC **D15/7**
CPC **F16K 51/02** (2013.01)

(58) **Field of Classification Search**

USPC D15/7, 9, 11, 17, 21, 28, 123, 199;
D23/269, 386, 259; D8/349;
277/602-626; 285/95, 109, 336, 910, 918
CPC F16K 51/02; F16J 15/025; F16J 15/0887;
F16J 15/104; F16J 15/128

See application file for complete search history.

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Primary Examiner — Richard E Chilcot

(74) *Attorney, Agent, or Firm* — The Webb Law Firm

(57) **CLAIM**

The ornamental design for seal member for use in semiconductor production apparatus, as shown and described.

DESCRIPTION

1.1 is a perspective view of a seal member for use in semiconductor production apparatus, showing my new design;

1.2 is a front elevation view thereof;

1.3 is a rear elevation view thereof;

1.4 is a left side elevation view thereof;

1.5 is a right side elevation view thereof;

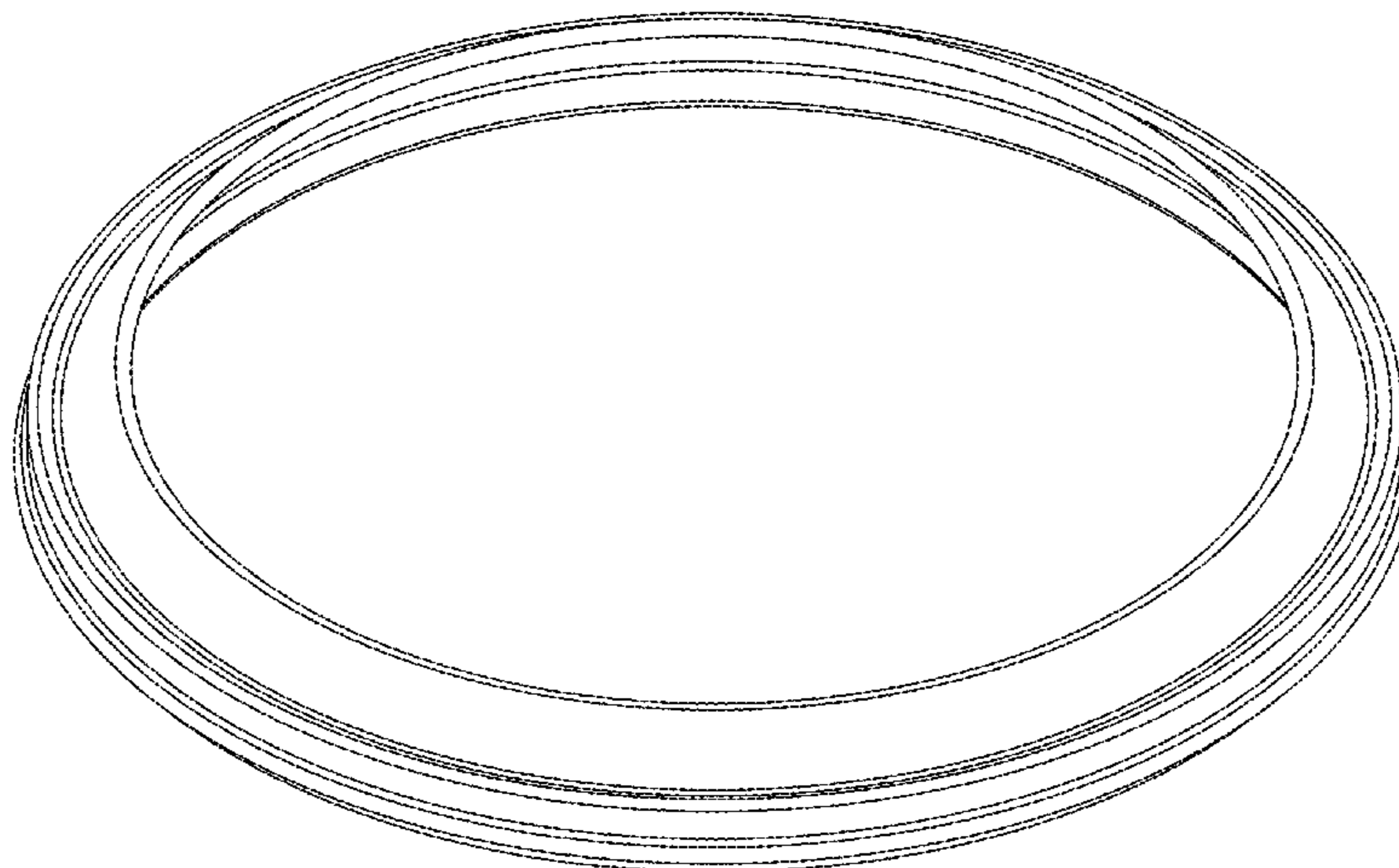
1.6 is a top view thereof;

1.7 is a bottom view thereof;

1.8 is a cross-sectional view thereof taken along lines **1.8-1.8** shown in **Reproduction 1.6**; and

1.9 is an enlarged cross-sectional view of a portion thereof taken from area **1.9** shown in **Reproduction 1.8**.

1 Claim, 9 Drawing Sheets



(56)

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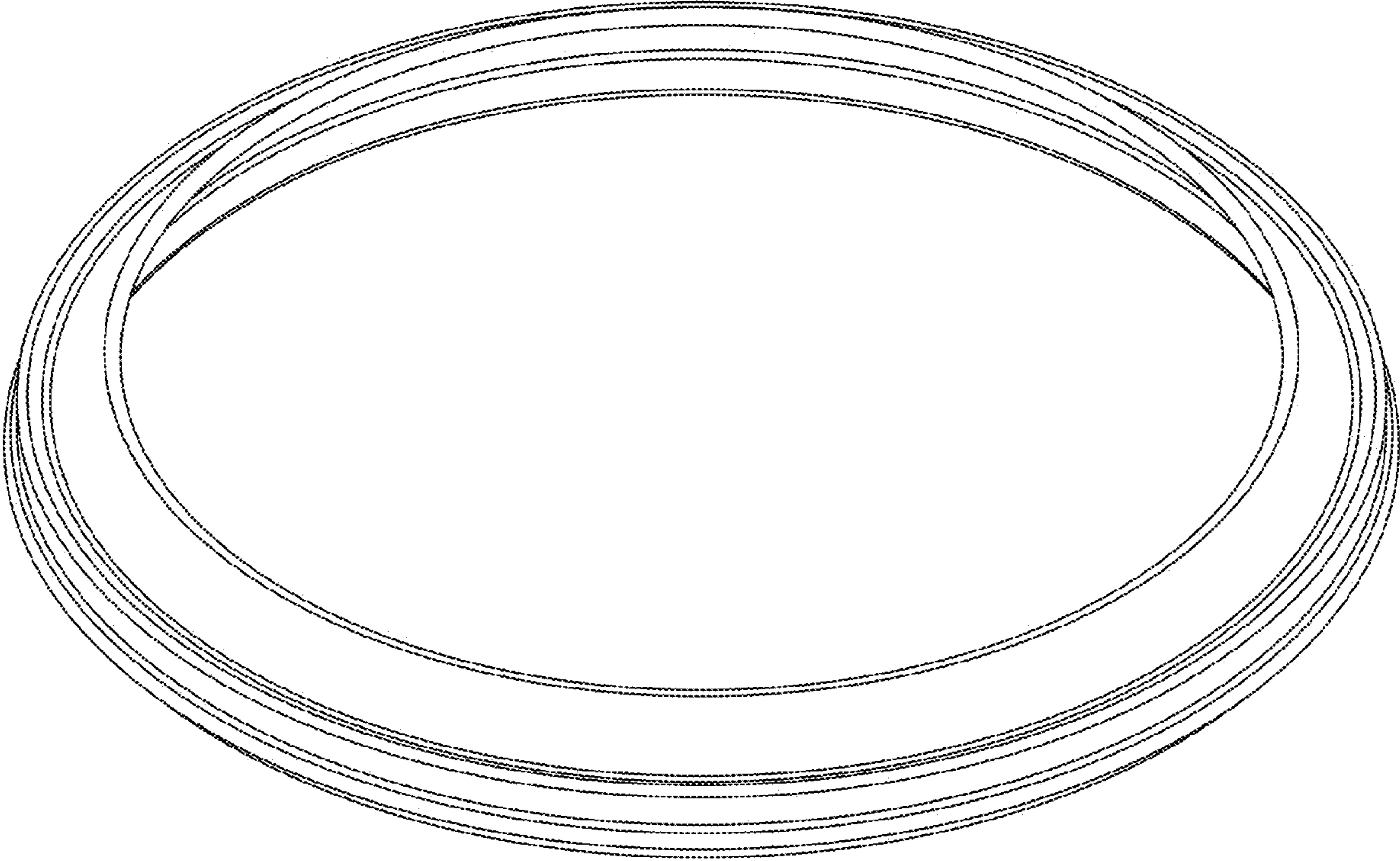
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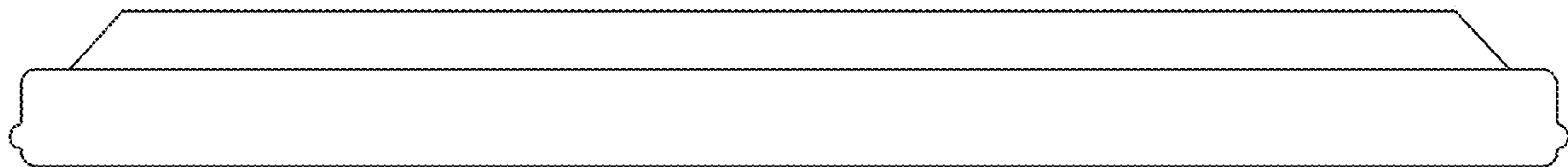
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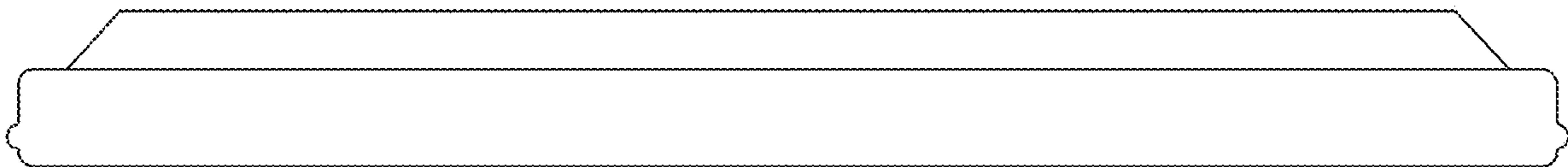
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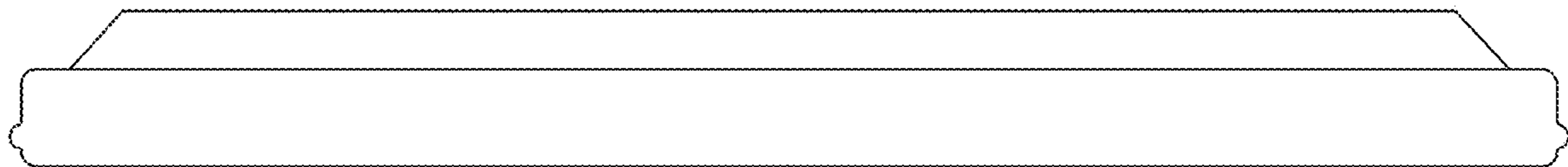
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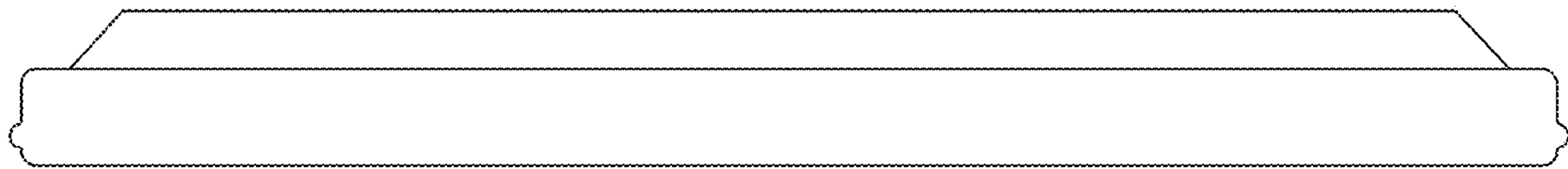
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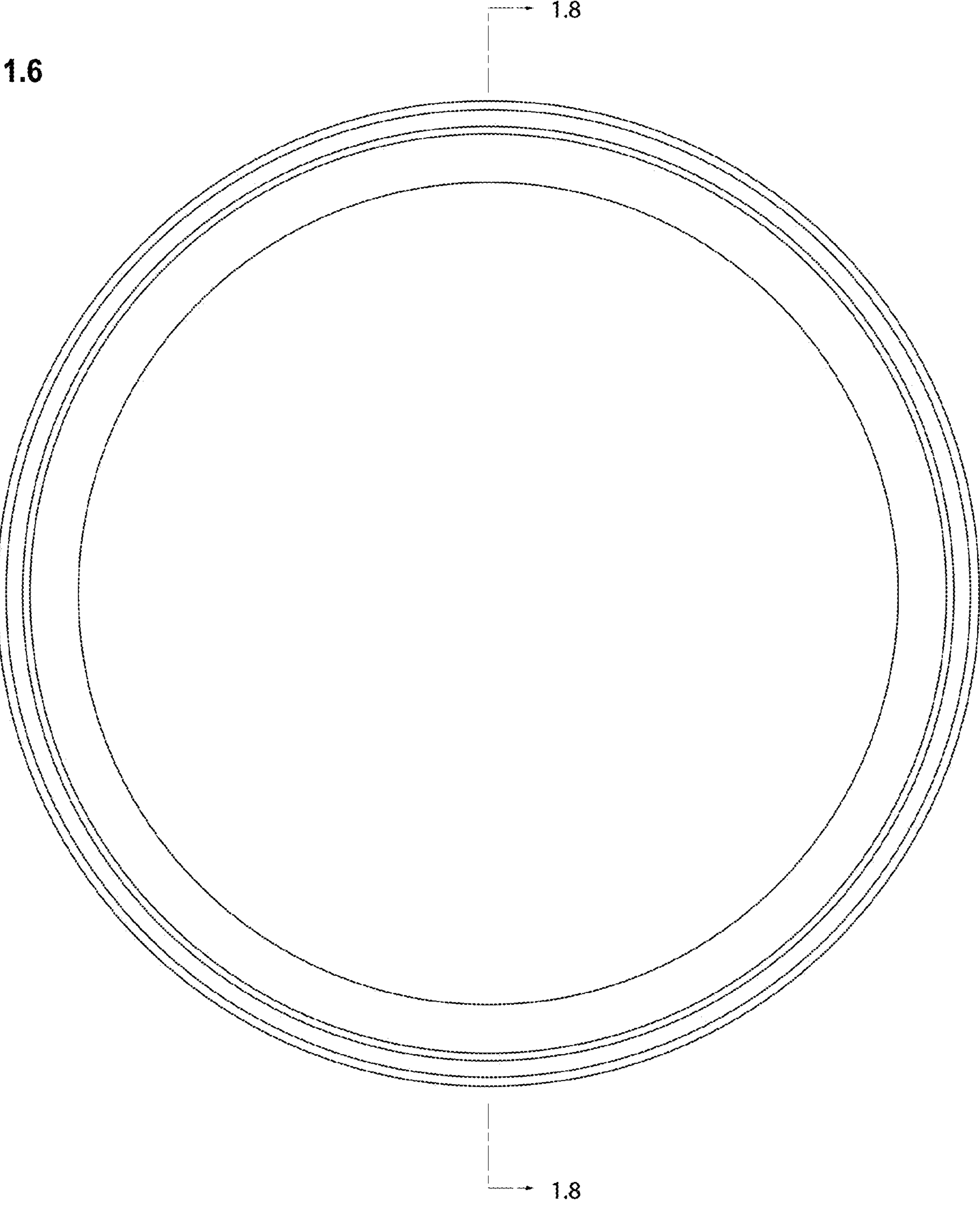


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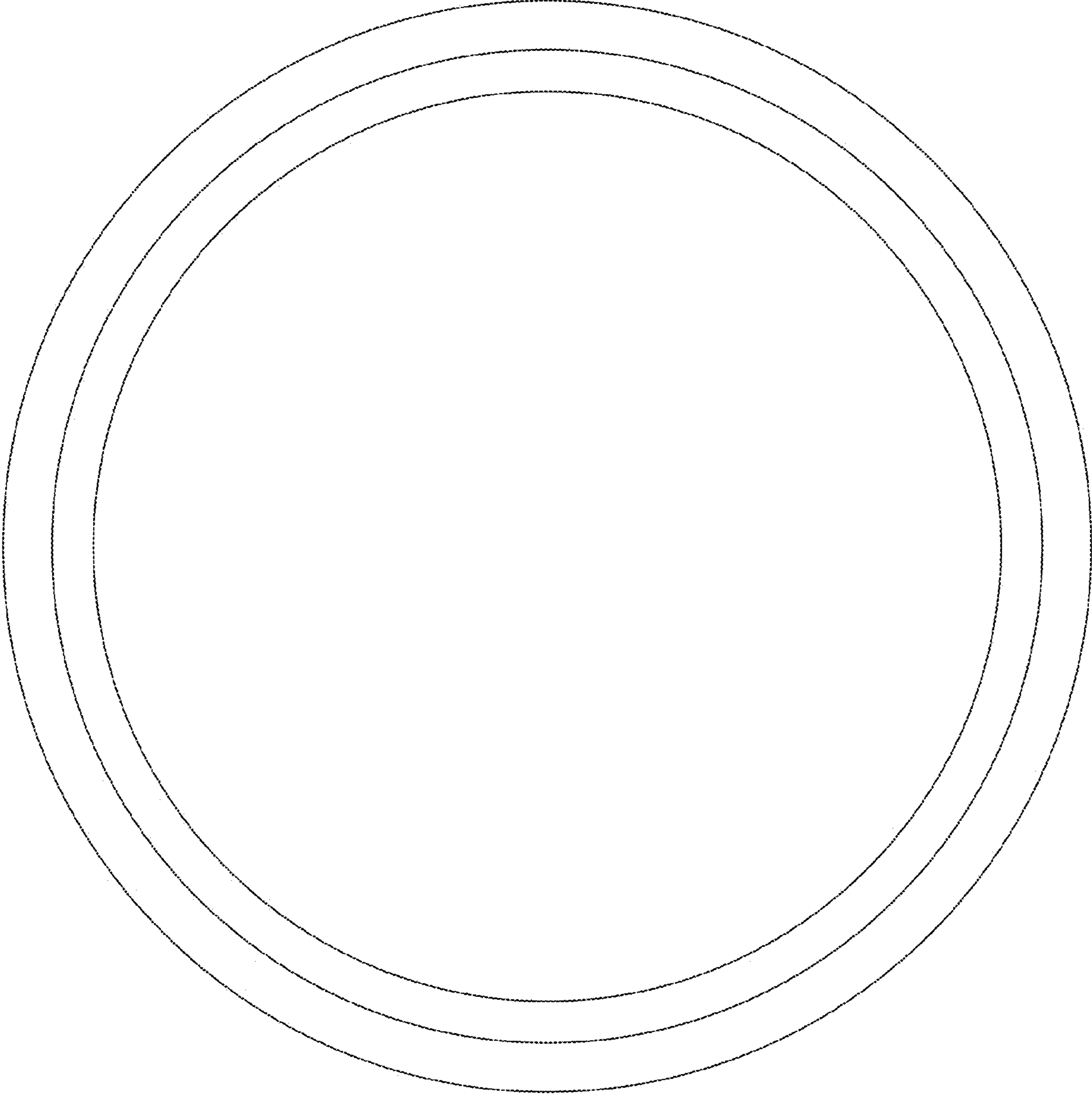


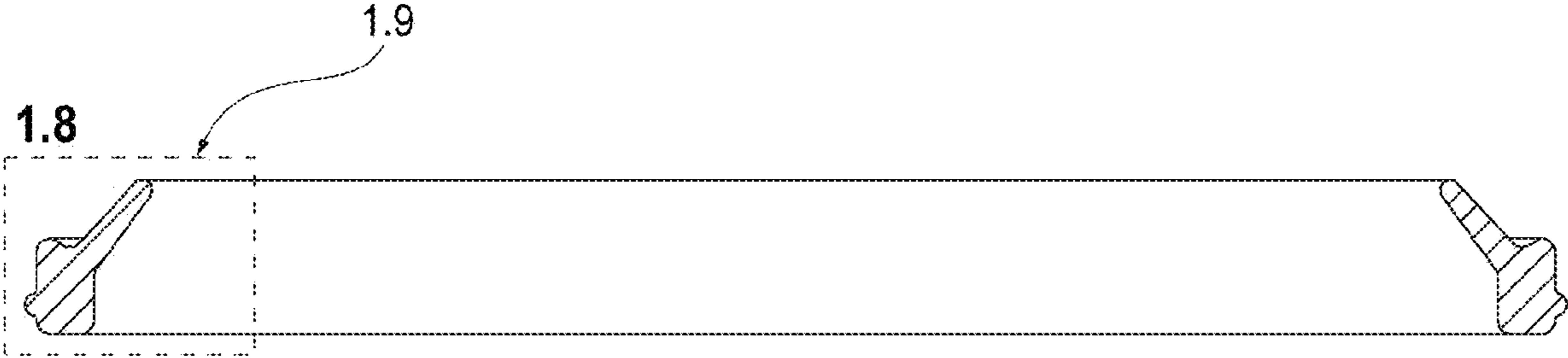
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1.7





1.9

